



**2018 IEEE 7th Asia-Pacific Conference on
Antennas and Propagation**

August 5-8, 2018, Auckland, New Zealand

CALL FOR EXHIBITION & SPONSORSHIP

Dear Valued Exhibitors & Sponsors,

The 2018 IEEE 7th Asia-Pacific Conference on Antennas and Propagation (APCAP) will be held in Auckland, New Zealand from August 5-8, 2018. The APCAP is an important international event in the areas of antennas and propagation, which will have over 200 delegates who are R&D professionals from industrial companies, academia, and research organizations worldwide.

The APCAP 2018 will feature an International Antenna/Microwave Exhibition, providing an excellent opportunity for your company to exhibit your equipment, software or services related to antenna and microwave. The relevant information is enclosed for your esteemed consideration.

As General Chair and Logistics & Exhibition Chair of the APCAP 2018, we would like to invite you to consider participating in the International Antenna/Microwave Exhibition at APCAP 2018 and/or making generous sponsorship.

You are welcome to visit our conference website at <http://www.apcap2018.org>. You may also contact our Logistics & Exhibition Chair **Dr. Terence SEE** by email at spsee@i2r.a-star.edu.sg.

We look forward to hearing from you, and seeing you at APCAP 2018 in Auckland, New Zealand!

Prof. Zhi Ning CHEN
General Chair
eleczn@nus.edu.sg

Dr. Terence SEE
Logistics & Exhibition Chair
spsee@i2r.a-star.edu.sg



EXHIBITION & SPONSORSHIP - REPLY SLIP

We are pleased to offer the following Exhibitor/Sponsorship Program to IEEE APCAP 2018 and will abide by the rules of this sponsorship set by the Conference Organizing Committee.

CATEGORY	SUMMARY OF BENEFITS	CHOICE
Platinum (USD6,000)	One large size exhibition booth. Two complimentary registrations including banquet dinner; One full-page color advertisement in Final Program; Company logo display on Conference Banner; Web link; Promotional Inserts.	<input type="checkbox"/>
Gold (USD4,000)	One medium size exhibition booth; Two complimentary registrations including banquet dinner; One full-page color advertisement in Final Program; Company logo display on Conference Banner; Web link; Promotional Inserts.	<input type="checkbox"/>
Silver (USD3,000)	One medium size exhibition booth; One complimentary registration including banquet dinner; One full-page b/w advertisement in Final Program; Web link; Promotional Inserts.	<input type="checkbox"/>
Bronze (USD2,000)	One small size exhibition booth; One full-page b/w advertisement in Final Program; Web link; Promotional Inserts.	<input type="checkbox"/>
Others	Please suggest and specify.	<input type="checkbox"/>

Date: _____

Company: _____

Address: _____

Contact Name: _____ Designation: _____

Telephone: _____ Mobile Phone: _____ Fax: _____

Email: _____

Signature: _____ Company Stamp: _____

Enclosed please find the Cheque No. _____ for the amount USD _____ made payable to

“IEEE APCAP 2018”. Kindly send the cheque to:

Dr. Terence SEE, Logistics & Exhibition Chair
 Institute for Infocomm Research
 1 Fusionopolis Way, #21-01 Connexis (South Tower), Singapore 138632
 Telephone: +65-6408 2377
 Fax: +65-6776 1378
 Email: spsee@i2r.a-star.edu.sg

Note: Our Exhibition/Sponsorship Program is flexible and open to alternative suggestions for participation. All sponsorship amounts are inclusive of local taxes.